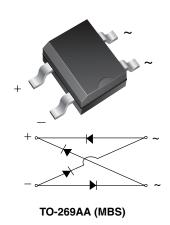


Vishay General Semiconductor

Miniature Glass Passivated Single-Phase Surface Mount Bridge Rectifier



| PRIMARY CHARACTERISTICS | | | | | |
|--------------------------|---------------------|--|--|--|--|
| I _{F(AV)} 0.5 A | | | | | |
| V _{RRM} | 200 V, 400 V, 600 V | | | | |
| I _{FSM} | 35 A | | | | |
| I _R | 5 μΑ | | | | |
| V _F | 1.0 V | | | | |
| T _J max. | 150 °C | | | | |

FEATURES





· Saves space on printed circuit boards



· Ideal for automated placement

High surge current capability

RoHS

 Meets MSL level 1, per J-STD-020, LF maximum peak of 250 °C

• Solder dip 260 °C, 40 s

 Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

TYPICAL APPLICATIONS

General purpose use in ac-to-dc bridge full wave rectification for power supply, lighting ballaster, Battery charger, home appliances, office equipment, and telecommunication applications.

MECHANICAL DATA

Case: TO-269AA (MBS)

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class

1A whisker test

Polarity: As marked on body

| PARAMETER | SYMBOL | MB2S | MB4S | MB6S | UNIT |
|---|-----------------------------------|--|------|------|------------------|
| Device marking code | | 2 | 4 | 6 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 200 | 400 | 600 | V |
| Maximum RMS voltage | V _{RMS} | 140 280 420 | | 420 | V |
| Maximum DC blocking voltage | V _{DC} 200 | | 400 | 600 | V |
| Maximum average forward output rectified current (Fig. 1) on glass-epoxy P.C.B. on aluminum substrate | I _{F(AV)} | 0.5 ⁽¹⁾ 0.8 ⁽²⁾ | | | А |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 35 | | | А |
| Rating for fusing (t < 8.3 ms) | I ² t | 5.0 | | | A ² s |
| Operating junction and storage temperature range | T _J , T _{STG} | - 55 to + 150 | | | °C |

Notes:

- (1) On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3 mm) pads
- (2) On aluminum substrate P.C.B. with an area of 0.8" \times 0.8" (20 \times 20 mm) mounted on 0.05 \times 0.05" (1.3 \times 1.3 mm) solder pad

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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|---|----------------|------------|------|------|------|
| PARAMETER | TEST CONDITIONS | SYMBOL | MB2S | MB4S | MB6S | UNIT |
| Maximum instantaneous forward voltage drop per diode | 0.4 A | V _F | | 1.0 | | ٧ |
| Maximum DC reverse current at rated DC blocking voltage per diode | T _A = 25 °C T _A = 125 °C | I _R | 5.0 100 | | μΑ | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | CJ | 13 | | pF | |

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | |
|---|--|---|------|------|------|
| PARAMETER | SYMBOL | MB2S | MB4S | MB6S | UNIT |
| Typical thermal resistance | $egin{array}{l} R_{	hetaJA} \ R_{	hetaJA} \ R_{	hetaJL} \end{array}$ | 85 ⁽¹⁾ 70 ⁽²⁾ 20 ⁽¹⁾ | | | °C/W |

Notes:

- (1) On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3 mm) pads
- (2) On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20 mm) mounted on 0.05 x 0.05" (1.3 x 1.3 mm) solder pad

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|----------------------------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| MB2S-E3/45 | 0.22 | 45 | 100 | Tube | | |
| MB2S-E3/80 | 0.22 | 80 | 3000 | 13" diameter paper tape and reel | | |

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

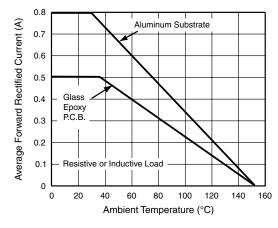


Figure 1. Derating Curve for Output Rectified Current

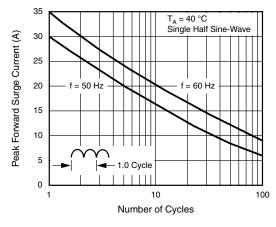


Figure 2. Maximum Non-Repetitive Peak Forward Surge
Current Per Diode



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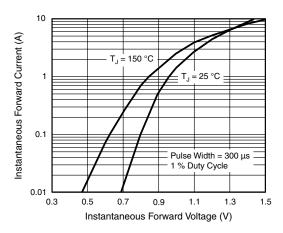


Figure 3. Typical Forward Voltage Characteristics Per Diode

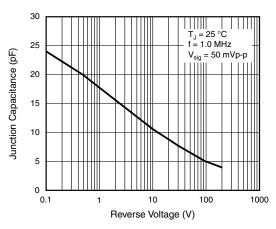


Figure 5. Typical Junction Capacitance Per Diode

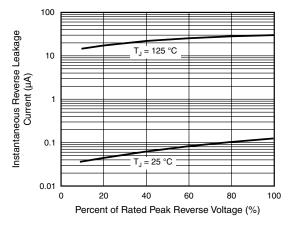
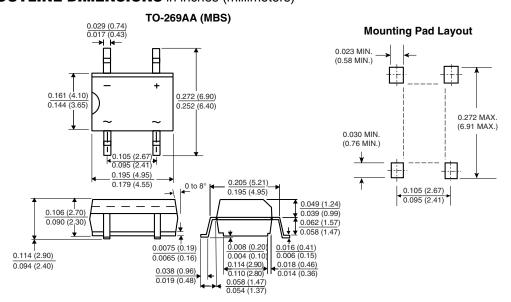


Figure 4. Typical Reverse Leakage Characteristics Per Diode

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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